MMK75U160UX

1600V 75A thyristor Module
RoHS Compliant

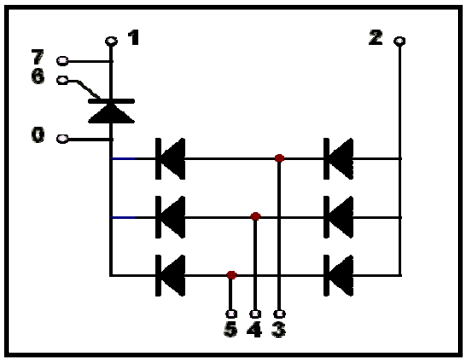
September 2010 **PRELIMINARY**

Features

· Isolated Module Package
· Isolation voltage 3000 V
· Three Phase Bridge and a Thyristor

Applications

- Current Stabilized Power Supply
- Switching Power Supply
- Inverter For AC or DC Motor Control



■ Diode

ABSOLUTE MAXIMUM RATINGS

T_C=25°C unless otherwise specified

Symbol	Parameter	Test Conditions	Max.	Unit
V_{RRM}	Repetitive Reverse Voltage		1600	V
$I_{D(AV)}$	Average Forward Current	T_C=90°C, moudle	75	A
I_{FSM}	Non-Repetitive Surge Forward Current	T_J=45°C, t=10ms, 50Hz, Sine	1050	A
		T_J=45°C, t=8.3ms, 60Hz, Sine	1150	A
I^2t	I^2t (For Fusing)	T_J=45°C, t=10ms, 50Hz, Sine	5.5	kA^2s
		T_J=45°C, t=8.3ms, 60Hz, Sine	5.4	kA^2s
T_J	Junction Temperature		-40 to +150	°C
T_{STG}	Storage Temperature Range		-40 to +125	°C
V_{isol}	Insulation Test Voltage	AC, 50Hz, t=1min	3000	V
Weight			215	g

ELECTRICAL AND THERMAL CHARACTERISTICS

T_C=25°C unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Reverse Leakage Current	V_R=1600V	--	--	500	μA
		V_R=1600V, T_J=125°C	--	--	5	mA
V_F	Forward Voltage	I_F=75A	--	1.05	--	V
		I_F=75A, T_J=125°C	--	1.0	--	V
$R_{\theta JC}$	Thermal Resistance Junction-to-Case	per diode	--	--	0.9	°C /W
		per module	--	--	0.15	°C /W
$R_{\theta CS}$	Thermal Resistance Case -to-Sink	per diode	--	--	0.48	°C /W
		per module	--	--	0.08	°C /W

MacMic Science & Technology Co., Ltd.

Add：#18, Hua Shan Zhong Lu, New District, Changzhou City, Jiangsu Province, P. R .of China

Tel.：+86-519-85163708 Fax：+86-519-85162291 Post Code：213022 Website：www.macmicst.com

■ Thyristor

ABSOLUTE MAXIMUM RATINGS

T_C=25°C unless otherwise specified

Symbol	Test Condition	Value	Unit
V_{RRM}		1600	V
$I_{T(AV)}$	T_C=90℃, 180° conduction, half sine wave;	75	A
I_{TSM}	T_J=45℃, t=10ms (50Hz), sine, V_R=V_{RRM};	1200	A
	T_J=45℃, t=8.3 ms (60Hz), sine, V_R= V_{RRM};	1300	
I^2t	T_J=45℃, t=10ms (50Hz), sine, V_R=V_{RRM};	7.2	kA^2s
	T_J=45℃, t=8.3 ms (60Hz), sine, V_R= V_{RRM};	7.0	
dV/dt	T_J=125℃, exponential to 67% rated V_{DRM}	1000	V/us
dI/dt	T_J=125℃, I_{TM}=200A, rated V_{DRM}	150	A/us
V_{ISOL}	50Hz, all terminals shorted, t=1s, I_{ISOL}≤1mA ;	3000	V~
T_J	Max. junction operating temperature range	-40～125	℃
T_{STG}	Max. storage temperature range	-40～125	℃
	Mounting torque(M6)	3 to 5	N·m
	Terminal connection torque(M5)	2.5 to 5	N·m

ELECTRICAL AND THERMAL CHARACTERISTICS

T_C=25°C unless otherwise specified

Symbol	Test Condition	Min.	Typ.	Max.	Unit
I_{DRM}/I_{RRM}	T_J=125℃, V_D=V_R=1600V;			20	mA
V_{TM}	I_{TM}=235A, t_d=10 ms, half sine;		1.50		V
V_{GT}	V_A=6V, R_A=1Ω, Tj=-40°C;			4	V
	V_A=6V, R_A=1Ω;			2.5	
	V_A=6V, R_A=1Ω, Tj=125°C;			1.7	
I_{GT}	V_A=6V, R_A=1Ω, Tj=-40°C;			270	mA
	V_A=6V, R_A=1Ω;			150	
	V_A=6V, R_A=1Ω, Tj=125°C;			80	
P_{GM}	tp≤5ms, Tj=125°C;			12	W
$P_{GM(AV)}$	f=50Hz, Tj=125°C;			3	W
R_{thjc}	Thermal Resistance , Junction-to-Case			0.35	K/W
R_{THCS}	Thermal Resistance, Case -to-Sink			0.15	K/W

Characteristic curves

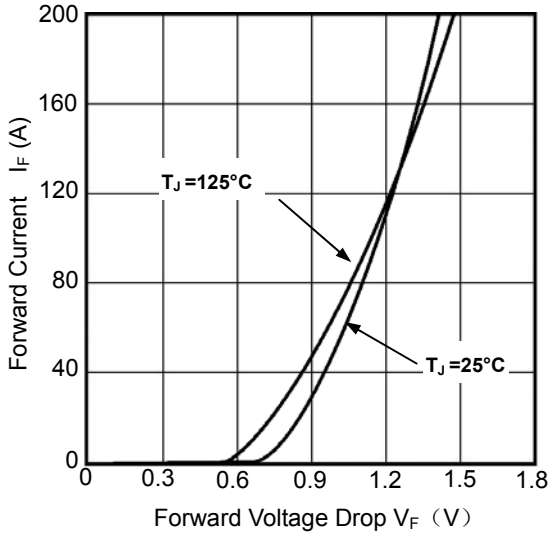


Figure1. Diode Forward Voltage Drop vs Forward Current

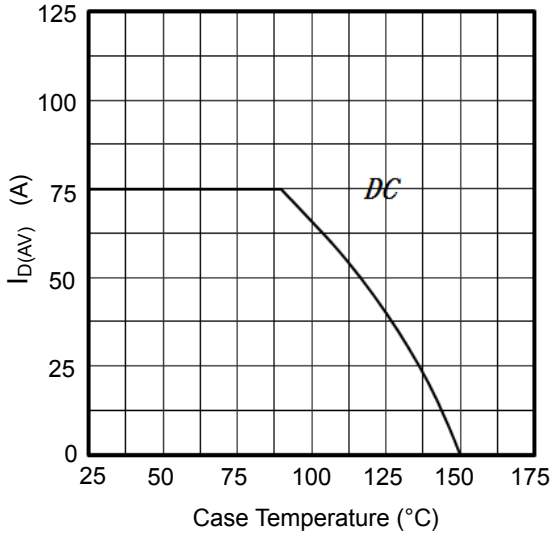


Figure 2. Diode $I_{D(AV)}$ vs Case Temperature

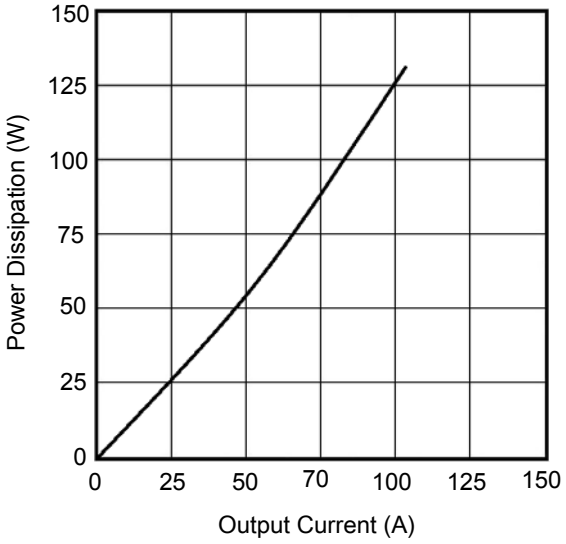


Figure 3. SCR Output Current vs Power Dissipation

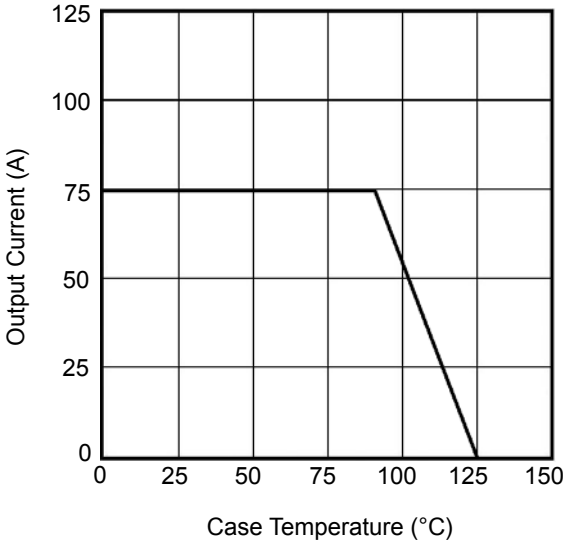


Figure 4. SCR Output Current vs Case Temperature

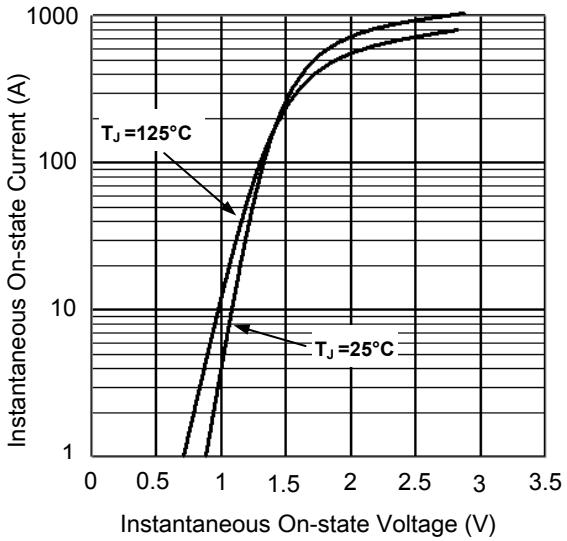


Figure 5. SCR On State Voltage Drop

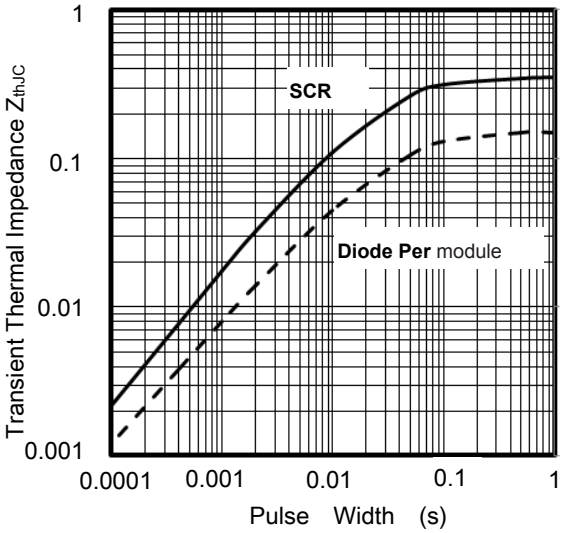


Figure 6. Diode and SCR Thermal Impedance Z_{thJC}

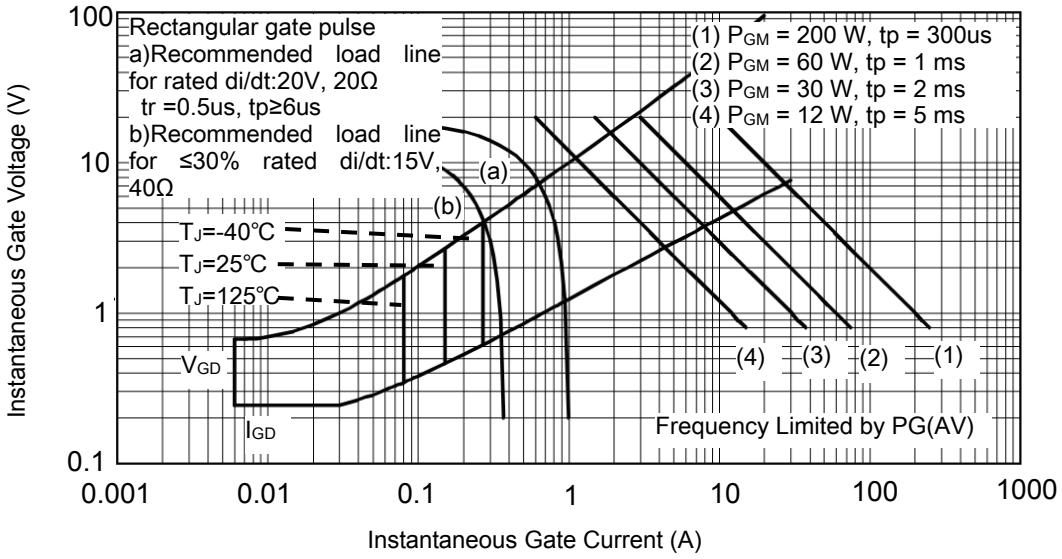


Figure 7. Gate Characteristics

Package Outline (Dimensions in mm)